



Parameter	Rating	Units
Blocking Voltage	600	V_P
Load Current	0.5	A_{rms} / A_{DC}
On-Resistance (max)	6	Ω
Input / Output Isolation	4	kV

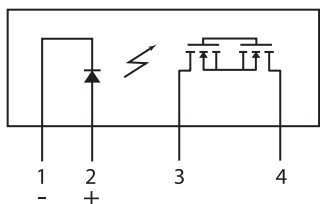
Features

- 4000V_{rms} Input/Output Isolation
- Handle Load Currents Up to 0.5A
- 600V_P Blocking Voltage
- Power SIP Package
- High Reliability
- Low Drive Power Requirements
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Flammability Rating UL 94 V-0

Applications

- Industrial Controls
- Motor Control
- Robotics
- Medical Equipment—Patient/Equipment Isolation
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- IC Equipment
- Home Appliances

Pin Configuration



Description

IXYS Integrated Circuits brings OptoMOS® technology, reliability, and compact size to a new family of high power Solid State Relays.

As part of this family, the CPC1983YE single-pole normally open (1-Form-A) Solid State Power Relay is rated for up to 0.5A_{DC} / 0.5A_{rms} continuous load current.

The CPC1983YE employs optically coupled MOSFET technology to provide 4000V_{rms} of input to output isolation. The optically coupled outputs, that use patented OptoMOS architecture, are controlled by a highly efficient infrared LED.

This combination of low on-resistance and high load current handling capability makes this relay suitable for a variety of high performance switching applications.

The "E" suffix signifies an enhanced isolation voltage.

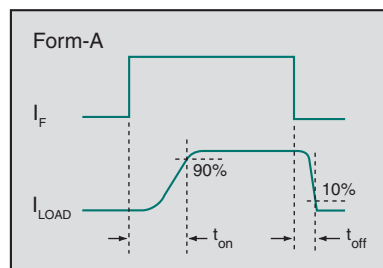
Approvals

- UL Recognized Component: File E69938

Ordering Information

Part #	Description
CPC1983YE	4-Pin (8-Pin Body) Power SIP Package (25 per tube)

Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	600	V _P
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation ¹	150	mW
Total Power Dissipation ²	2400	mW
Isolation Voltage, Input to Output ³	4000	V _{rms}
ESD Rating, Human Body Model	8	kV
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

¹ Derate linearly 1.33 mW / °C

² Derate linearly 20 mW / °C

³ UL File 69938 is only rated by UL to 2500V_{rms}

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at +25°C, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

Electrical Characteristics @ 25°C

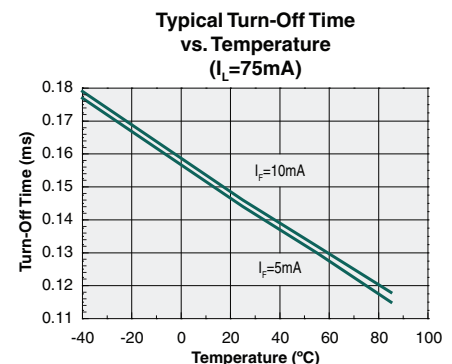
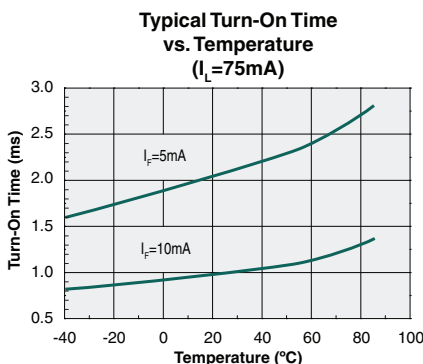
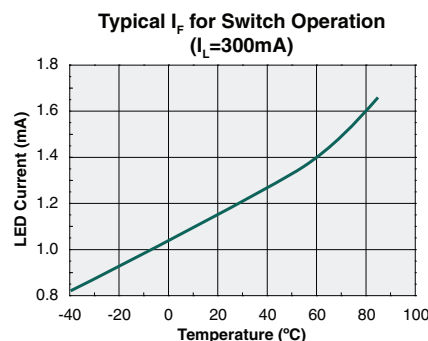
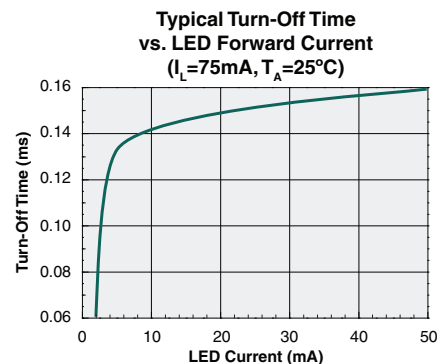
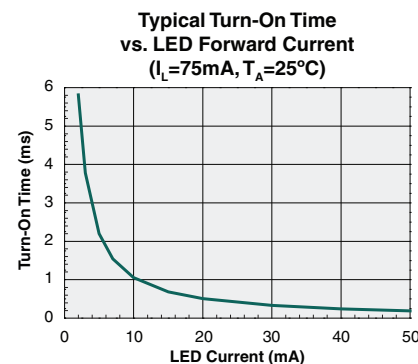
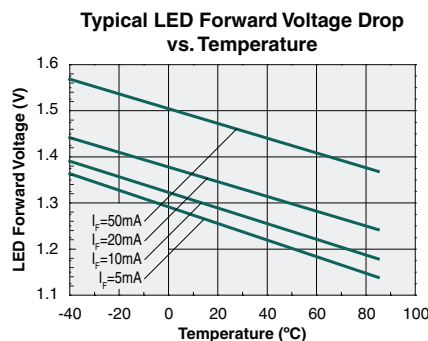
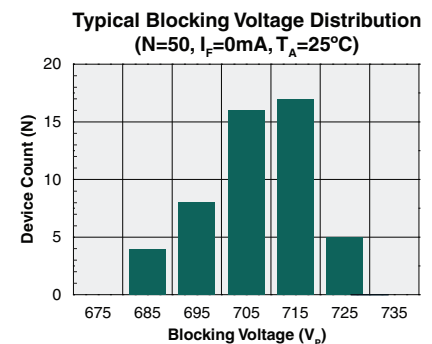
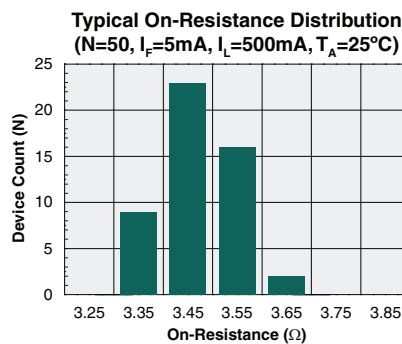
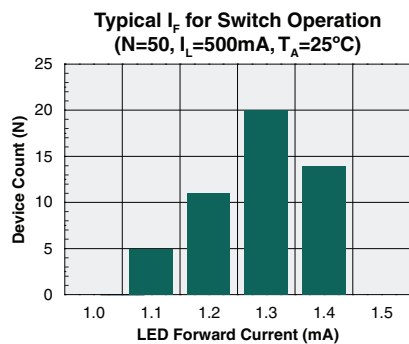
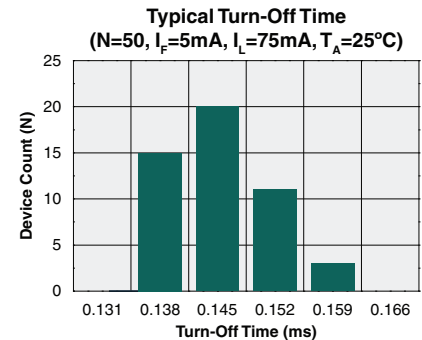
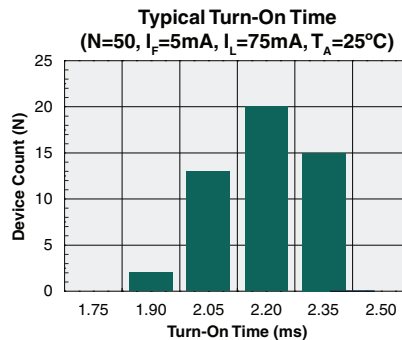
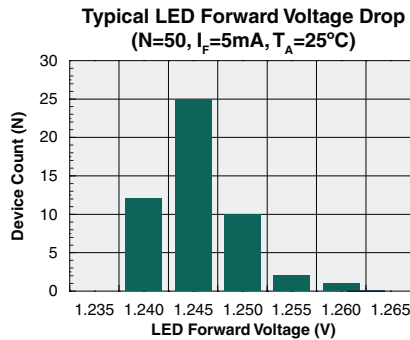
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current, Continuous	I _F =5mA, Free air	I _L	-	-	0.5	A _{rms} / A _{DC}
Peak Load Current	I _F =5mA, t=10ms	I _{LPK}	-	-	±3	A _p
On-Resistance ¹	I _F =5mA, I _L =0.5A	R _{ON}	-	3.5	6	Ω
Off-State Leakage Current	I _F =0mA, V _L =600V _P	I _{LEAK}	-	-	1	μA
Switching Speeds	I _F =5mA, V _L =10V	t _{on}	-	2.2	5	ms
Turn-On			-	0.15	2	
Turn-Off		t _{off}	-	0.15	2	
Output Capacitance	I _F =0mA, 50V, f=1MHz	C _{OUT}	-	41	-	pF
Input Characteristics						
Input Control Current to Activate	I _L =0.5A	I _F	-	1.3	5	mA
Input Control Current to Deactivate	-	I _F	0.5	-	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Input/Output Characteristics						
Capacitance Input/Output	V _{IO} =0V, f=1MHz	C _{IO}	-	2	-	pF

¹ Measurement taken within 1 second of on-time.

Thermal Characteristics

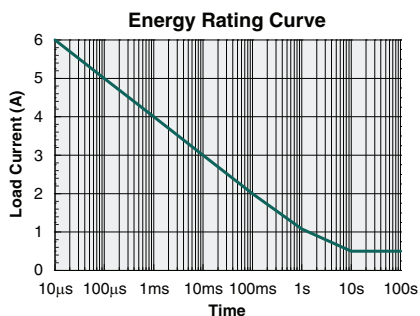
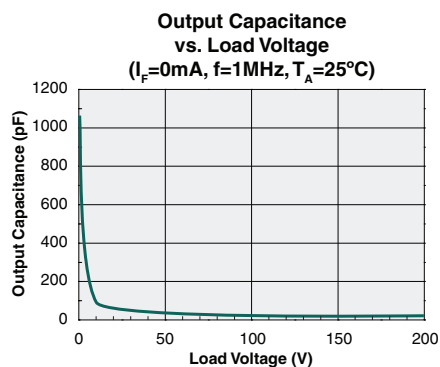
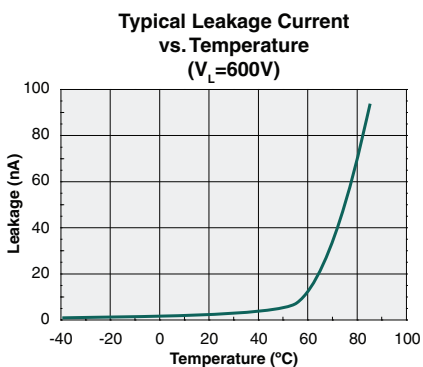
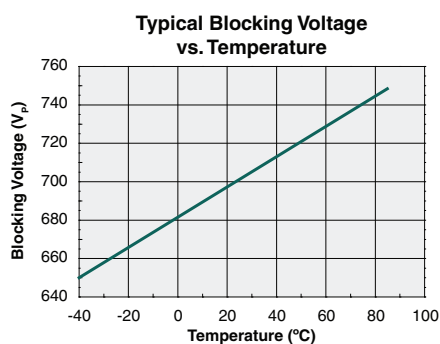
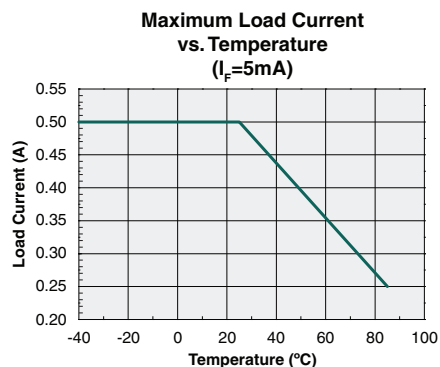
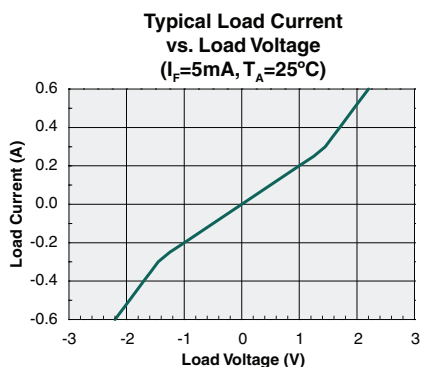
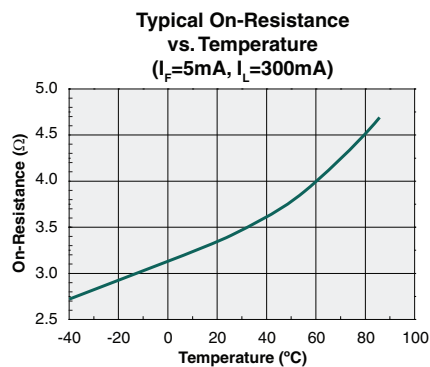
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Thermal Impedance (junction to case)	-	R _{θJC}	-	1.5	-	°C/W

PERFORMANCE DATA *



*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C .
For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*



*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C.
For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Classification
CPC1983YE	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Soldering Profile

Provided in the table below is the Classification Temperature (T_C) of this product and the maximum dwell time the body temperature of this device may be ($T_C - 5$)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

Device	Classification Temperature (T_C)	Dwell Time (t_p)	Max Reflow Cycles
CPC1983YE	245°C	30 seconds	1

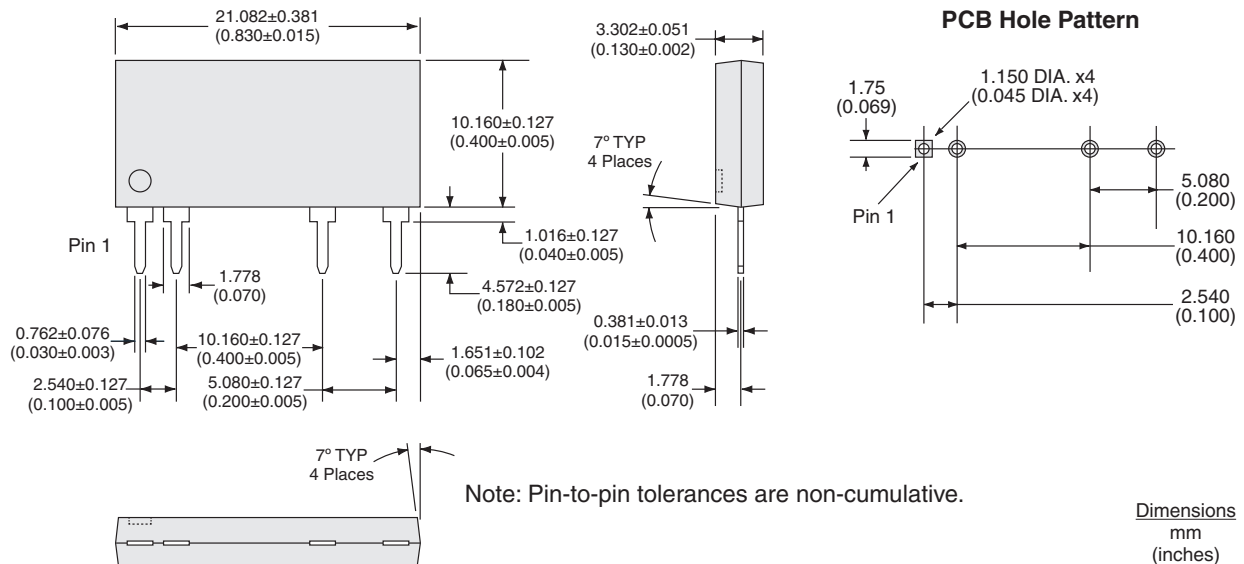
Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



MECHANICAL DIMENSIONS

CPC1983YE



For additional information please visit our website at: www.ixysic.com

IXYS Integrated Circuits makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits' Standard Terms and Conditions of Sale, IXYS Integrated Circuits assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits' product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits reserves the right to discontinue or make changes to its products at any time without notice.

Specification: DS-CPC1983YE-R03
©Copyright 2018, IXYS Integrated Circuits
OptoMOS® is a registered trademark of IXYS Integrated Circuits
All rights reserved. Printed in USA.
6/21/2018

The information below supercedes any previously presented material.

For additional information please visit our website at: <https://www.littelfuse.com>



Disclaimer Notice - Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications. Read complete Disclaimer Notice at www.littelfuse.com/disclaimer-electronics.